Serial No. 10/814.693 Docket No. 125686-5

AMENDMENTS TO THE CLAIMS

 (Previously Presented) A method for protecting an article from a high temperature, oxidative environment, said method comprising:

providing a substrate;

coating said substrate with a metal layer, the metal layer comprising at least one metal selected from the group consisting of platinum and palladium:

providing an ion plasma deposition target, said target comprising

from about 2 atom percent to about 25 atom percent chromium,

and

the balance comprising aluminum; and

depositing a protective coating onto said metal layer using said target in an ion plasma deposition process.

- (Original) The method of claim 1, wherein providing said target comprises
 providing a target further comprising a material selected from the group consisting of
 zirconium, hafnium, tantalum, silicon, yttrium, titanium, lanthanum, cerium, carbon, boron,
 and combinations thereof.
- 3. (Previously Presented) The method of claim 2, wherein providing said target comprises providing a target further comprising up to about 4 atom percent of a material selected from the group consisting of zirconium, hafnium, tantalum, silicon, yttrium, titanium, lanthanum, cerium, and combinations thereof; and up to about 0.2 atom percent of a material selected from the group consisting of carbon, boron, and combinations thereof.
- (Original) The method of claim 3, wherein providing said target comprises providing a target comprising

about 9 atom percent chromium,

about 1 atom percent zirconium, and

the balance comprising aluminum.

 (Original) The method of claim 3, wherein providing said target comprises providing a target comprising

about 9 atom percent chromium,

about 1 atom percent zirconium,

about 2 atom percent tantalum, and

the balance comprising aluminum.

 (Original) The method of claim 3, wherein providing said target comprises providing a target comprising

about 9 atom percent chromium,

about 1.5 atom percent hafnium,

about 1.5 atom percent silicon, and

at least about 85 atom percent aluminum.

- 7-8 (Canceled)
- 9. (Previously Presented) The method of claim 1, further comprising:

heat treating said substrate after coating said substrate with said metal layer.

10. (Original) The method of claim 9, wherein heat treating comprises heating said substrate to a temperature in the range from about 900°C to about 1200°C for a time in the range from about 30 minutes to about 8 hours.

- (Currently Amended) The method of claim <u>L</u>[[7]], wherein coating said substrate with a metal layer comprises coating with a layer having a thickness in the range from about 2 micrometers to about 25 micrometers.
- 12. (Original) The method of claim11, wherein coating said substrate with a metal layer comprises coating with a layer having a thickness in the range from about 2 micrometers to about 6 micrometers.
- (Original) The method of claim 1, further comprising heat treating said substrate after depositing said protective coating.
- 14. (Original) The method of claim 13, wherein heat treating comprises heating said substrate to a temperature in the range from about 700°C to about 1200°C for a time in the range from about 30 minutes to about 8 hours.
- 15. (Original) The method of claim 1, wherein providing said substrate comprises providing at least one of a nickel alloy, an iron alloy, and a cobalt alloy.
- (Original) The method of claim 15, wherein providing said substrate comprises providing a superalloy.
- 17. (Original) The method of claim 16, wherein providing said superalloy comprises providing a component for service in a hot gas path of a gas turbine assembly.
- (Original) The method of claim 1, wherein providing a substrate comprises providing a substrate comprising at least one coating.
- 19. (Original) The method of claim 1, wherein providing said ion plasma deposition target comprises providing a target manufactured using at least one of casting and powder metallurgy processing.
- (Original) The method of claim 1, wherein depositing said protective coating onto said substrate further comprises applying a negative potential bias to said substrate.

- (Original) The method of claim 20, wherein applying said negative potential bias comprises applying a potential bias in the range from about -10 volts to about -1000 volts.
- (Original) The method of claim 21, wherein applying said negative potential bias comprises applying a potential bias in the range from about -50 volts to about -250 volts.
- 23. (Original) The method of claim 1, wherein depositing said protective coating onto said substrate further comprises grounding said substrate.
- (Original) The method of claim1, wherein depositing said protective coating comprises depositing a protective coating having a thickness in the range from about 5 micrometers to about 250 micrometers.
- 25. (Original) The method of claim 24, wherein depositing said protective coating comprises depositing a protective coating having a thickness in the range from about 25 micrometers to about 75 micrometers.
- 26. (Original) The method of claim 1, further comprising coating said protective layer with a thermal barrier coating.
- 27. (Original) The method of claim 26, wherein coating said protective layer with a thermal barrier coating comprises coating said protective layer with a thermal barrier coating comprising yttria-stabilized zirconia.
- 28. (Original) The method of claim 1, wherein depositing said protective coating comprises forming a protective coating comprising at least 80 volume percent of a single phase.
- 29. (Original) The method of claim 28, wherein depositing said protective coating comprises forming a protective coating comprising at least 80 volume percent of a B2-structured aluminide intermetallic phase.

- (Original) The method of claim 1, wherein depositing said protective coating comprises forming a protective coating comprising at least two phases.
- (Original) The method of claim 30, wherein depositing said protective coating comprises forming a protective coating comprising a B2-structured aluminide intermetallic phase and platinum aluminide (PtAl2).
- 32. (Previously Presented) A method for protecting an article from a high temperature, oxidative environment, said method comprising:

providing a substrate comprising a nickel-based superalloy;

coating said substrate with a metal layer, the metal layer comprising at least one metal selected from the group consisting of platinum and palladium;

heat treating said substrate after coating said substrate with said metal layer;

providing an ion plasma deposition target, said target comprising

from about 2 atom percent to about 25 atom percent chromium,

up to about 4 atom percent of a material selected from the group consisting of zirconium, hafnium, tantalum, silicon, yttrium, titanium, lanthanum, cerium, and combinations thereof.

up to about 0.2 percent of a material selected from the group consisting of carbon, boron, and combinations thereof, and

at least about 70 atom percent aluminum;

depositing a protective coating onto said metal layer using said target in an ion plasma deposition process, wherein a negative potential bias is applied to said substrate during deposition of said protective coating; and

heat treating said substrate after depositing said protective coating;

wherein after heat treating, said protective coating comprises a B2-structured aluminide intermetallic phase.

33-41 (Canceled)

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